
RL78/G23 Simulator V1.03.00

Release Note

Thank you for using the RL78/G23 simulator.

This document describes restrictions on and points for caution regarding the simulator.

Read this document before using the product.

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Chapter 1. Target Devices and Supported Simulation Functions

The RL78/G23 simulator supports the following target devices.

Device group	Device name	
RL78/G23	128 pins	R7F100GSx (x = J, K, L, N)
	100 pins	R7F100GPx (x = G, H, J, K, L, N)
	80 pins	R7F100GMx (x = G, H, J, K, L, N)
	64 pins	R7F100GLx (x = F, G, H, J, K, L, N)
	52 pins	R7F100GJx (x = F, G, H, J, K, L, N)
	48 pins	R7F100GGx (x = F, G, H, J, K, L, N)
	44 pins	R7F100GFx (x = F, G, H, J, K, L, N)
	40 pins	R7F100GEx (x = F, G, H, J)
	36 pins	R7F100GCx (x = F, G, H, J)
	32 pins	R7F100GBx (x = F, G, H, J)
	30 pins	R7F100GAx (x = F, G, H, J)

As well as CPU instructions, the RL78/G23 simulator is capable of simulating the following items in the target devices.

- Peripheral modules such as timers, the serial array unit, the serial interface, and SNOOZE mode sequencer
- Virtual target board (simulation via the [I/O panel] window)
- MCU pin signal waveforms (simulation via the [Timing chart] window)
- Current drawn

Chapter 2. Changes

This chapter describes changes from V1.02.00 to V1.03.00 of the RL78/G23 simulator.

2.1 Improvements to the RL78/G23 simulator

2.1.1 Simulation of current drawn

Additions have been made to the product types supported for simulation of current drawn.

The simulation of current drawn has been made available for all products of the RL78/G23 group in this version.

[Additional product types]

80 pins: R7F100GMx (x = G, H, J)

64 pins: R7F100GLx (x = H, J)

52 pins: R7F100GJx (x = H, J)

48 pins: R7F100GGx (x = H, J)

44 pins: R7F100GFx (x = H, J)

40 pins: R7F100GEx (x = H, J)

36 pins: R7F100GCx (x = H, J)

32 pins: R7F100GBx (x = H, J)

30 pins: R7F100GAx (x = H, J)

Chapter 3. Points for Caution

This section lists points for caution on using the RL78/G23 simulator. These points for caution are in the following two categories.

- Differences in behavior between the target devices and the simulator due to simulator specifications
- Usage of simulation functions (operations in and configuration of the GUI windows)

CS+ for CC supports the [Virtual Board] panel which is described in those points for caution.

3.1 Differences in behavior between the target devices and the simulator

3.1.1 Peripheral functions not supported by the simulator

The simulator is not capable of simulating the following peripheral functions of the target devices.

- Regulator
- Power-on-reset circuit
- Voltage detector
- Flash self-programming
- Operation state control
- Capacitive touch sensing unit (CTS2L)
- Security function

3.1.2 Peripheral I/O redirection register (PIOR)

The peripheral I/O redirection register (PIOR) can be manipulated by a program or debugger operations to re-assign specific multiplexed pin functions to alternative port pins in the same way as on the actual device. Note, however, that the assignment of serial interface functions to port pins must not be changed since doing so will disable normal connections through the [Serial] window or the UART console of the [Virtual Board] panel.

After re-assigning a given pin function by using the PIOR, be sure to select the name of the port pin you are currently using in the [Select Pin] dialog box of the simulator GUI or "Connected To" of the component in the [Virtual Board] panel.

3.1.3 Special function registers (SFRs) for controlling port functions

The following SFRs which control port functions are not simulated.

Although read/write access for each register can proceed normally, the operation does not change even though the value is changed.

- Output current control enable register (CCDE)
- Output current select registers (CCSx)
- 40-mA port output control register (PTDC)

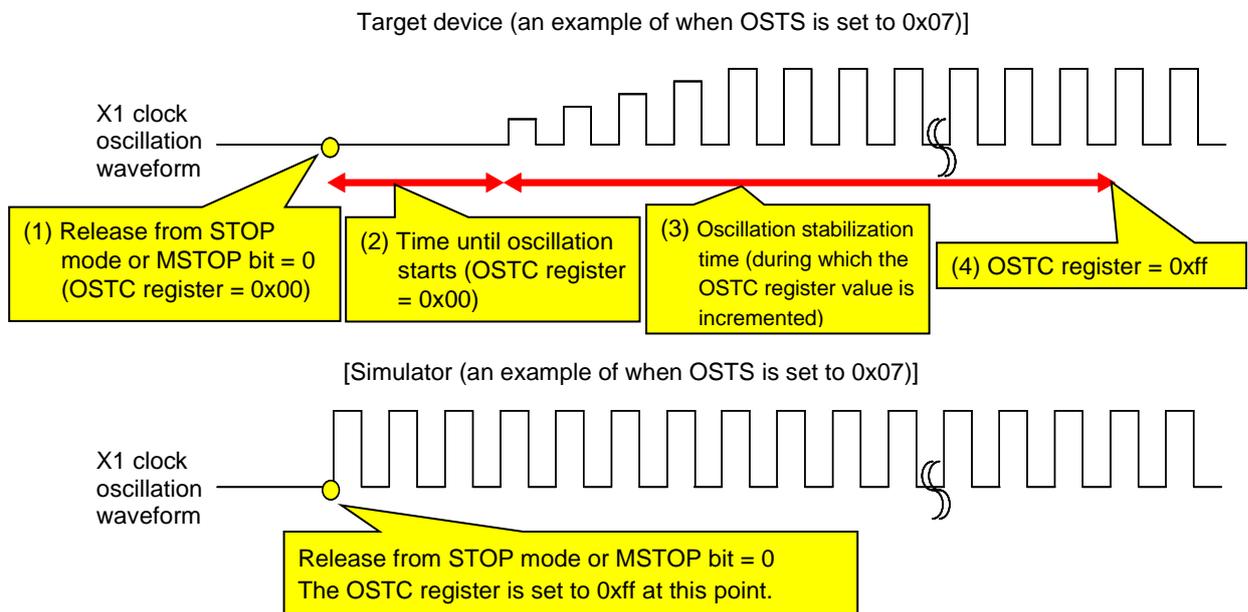
3.1.4 Oscillation stabilization time for the clock generator

Since the simulator does not simulate the clock oscillator oscillation stabilization time, stabilization always takes no time. When the oscillation is started, the OSTC register is set to one of the following values (i.e. not incremented).

OSTS Setting	OSTC Value
0x0 : $2^8/f_x$	0x80
0x1 : $2^9/f_x$	0xc0
0x2 : $2^{10}/f_x$	0xe0
0x3 : $2^{11}/f_x$	0xf0
0x4 : $2^{13}/f_x$	0xf8
0x5 : $2^{15}/f_x$	0xfc
0x6 : $2^{17}/f_x$	0xfe
0x7 : $2^{18}/f_x$	0xff

The following figure illustrates this operation.

In the target device, oscillation by the X1 clock starts after operation has passed through states (1) to (4). In the simulator, states (1) through (4) are skipped and oscillation instantly starts.



Therefore, pay attention to the code that waits for oscillation stabilization.

There is no problem if a program is created under the condition that execution proceeds after the oscillation stabilization wait period when the OSTC register value becomes the maximum value, or when the OSTC register value exceeds the specified value, but if a program is created under the condition that execution proceeds after the oscillation stabilization wait period when the OSTC register value becomes a value other than the maximum value, execution will enter an endless loop.

The following shows examples of code that causes and does not cause problems.

The examples are when the OSTC is set to 0x07.

<u>Correct code example (1)</u>	<u>Correct code example (2)</u>	<u>Example of code that may cause problems</u>
<pre>while(OSTC != 0xff) { NOP();/* wait */ }</pre>	<pre>while(OSTC <= 0xf0) { NOP();/* wait */ }</pre>	<pre>while(OSTC != 0xf0) { NOP();/* wait */ }</pre>

3.1.5 SFRs (CMC, OSMC, HIOTRM, MIOTRM, and LIOTRM) in the clock generator

The following SFRs which belong to the clock generator are not simulated. Although read/write access for each register can proceed normally, the operation does not change even if the value is changed.

- Bits 0, 1, and 2 (AMPH, AMPHS0, and AMPHS1) of the clock operating mode control register (CMC)
- Bit 0 (HIPREC)* of the subsystem clock supply mode control register (OSMC)
- High-speed on-chip oscillator trimming register (HIOTRM)
- Middle-speed on-chip oscillator trimming register (MIOTRM)
- Low-speed on-chip oscillator trimming register (LIOTRM)

Note: In the simulator, the HIPREC bit is fixed to 0. However, if the STOP instruction is executed, the RL78/G23 will enter the STOP mode.

The operation in initialization of the EXCLKS, OSCSELS, XTSEL, AMPHS1, and AMPHS0 bits of the clock operation mode control register (CMC) differs between the target device and the simulator.

[Target device]

EXCLKS, OSCSELS, XTSEL, AMPHS1, and AMPHS0 bits are only initialized by a power-on reset and retain their values following resetting by other reset sources.

[Simulator]

The bits are initialized by the following reset sources.

- External reset input via the _RESET pin
- Internal reset due to detection of a program malfunction by the watchdog timer

3.1.6 Operating clock of the timer array unit

Do not specify an operating clock that runs at or below 233 Hz. If the operating clock for the timer array unit runs at or below 233 Hz, then the timer array unit will not work properly (it will behave as if operating with a clock that is faster than the one selected).

3.1.7 Noise filter of the timer array unit

Although the target device's timer array unit has a function to turn the noise filters on and off in order to reduce noise from the timer input pins, the simulator does not simulate this function since there is no noise in the simulator's signals. That is, whether filtering is on or off makes no difference to the behavior.

3.1.8 1-Hz pin output of the real-time counter

If the waveform of the RTC1HZ pin is checked in the [Timing chart] window to use the 1-Hz pin output of the real-time counter, the output waveform frequency becomes 32.768 KHz.

In this case, proceed on the assumption that 1 Hz output is being produced without problems.

3.1.9 SFRs (RTCC0, RTCC1, and SUBCUD) of the realtime clock (RTC)

The operation of realtime clock control register 0 (RTCC0), realtime clock control register 1 (RTCC1), and the time error correction register (SUBCUD) of the realtime clock (RTC) differs between the target device and the simulator.

[Target device]

The registers are cleared to 00H in response to an internal reset by the power-on reset circuit.

[Simulator]

The registers are cleared to 00H in response to resetting by the following reset sources.

- External reset input via the _RESET pin
- Internal reset due to detection of a program malfunction by the watchdog timer

3.1.10 Interval interrupts generated by the watchdog timer

The timing of the generation of interval interrupts by the watchdog timer differs between the target device and the simulator.

[Target device]

When $75\% + 1/4f_{IL}$ of overflow time is reached

[Simulator]

When 75% of overflow time is reached

3.1.11 Clock used in the serial array unit

Do not specify a clock that is 233 Hz or lower in the following cases. If the following clock of the serial array unit is 233 Hz or lower, then the serial array unit will not operate correctly (it will behave as if operating via a clock that is faster than the one selected).

- Operating clock (f_{MCK}) is 233Hz or lower.
- Transfer clock setting by dividing the operation clock ($f_{MCK} \div (SDRmn[15:9] + 1)$) is 233Hz or lower.

3.1.12 Noise filter of the serial array unit

Although the target device's serial array unit has a function to turn the noise filter on and off in order to reduce noise on the input pin, the simulator does not simulate this function since there is no noise in the simulator's signals. That is, whether filtering is on or off makes no difference to the behavior.

3.1.13 SDRmn registers of the serial array unit

The values read from the seven higher-order bits of the serial data registers (SDRmn) during serial operation differ between the target device and the simulator.

[Target device]

0 is read.

[Simulator]

The value read is that at the time serial operation starts.

3.1.14 Input switch control register (ISC) of the serial array unit

When ISC2 to ISC7 bits of the input switch control register (ISC) are not set for normal operation, CSI communications are disabled in the [Serial] window. To enable CSI communications in the [Serial] window, clear the bits to 0.

3.1.15 IICA serial interface

IICA supports pin waveform generation and the communications through the [Serial] window. The following functions are not supported.

- Digital filter
- Arbitration
- Detection of transmission errors
- Communication reservation

3.1.16 Reset

The behavior differs as follows if a reset signal is input from the RESET pin.

[Target device]

The MCU is reset when the RESET pin goes low. Release from the reset state proceeds when the RESET pin goes high.

[Simulator]

The MCU is not reset when the RESET pin goes low. The simulator is reset momentarily and then released when the RESET pin goes high.

3.1.17 Reset control flag register (RESF)

The simulator only supports the WDTRF bit of the reset control flag register (RESF).

The simulator is not capable of simulating the operations of the other bits (TRAP, RPERF, IAWRF, and LVIRF). Only the default values of these bits are indicated.

The reset control flag register (RESF) of the target device is automatically cleared in the case of access to SFRs other than the RESF register after it has been read with an 8-bit memory manipulation instruction, but is not cleared in the simulator.

3.1.18 A/D converter

When no voltage is being applied to the VDD or AVREFP pin, the default reference voltage of the A/D converter is 5.0 V.

To change the reference voltage, input the desired voltage values for VDD and AVREFP via the [Signal Data Editor] window.

The temperature sensor output voltage is always 1.05 V.

3.1.19 Wait time for selecting the reference voltage on the positive side of the A/D converter

The simulator does not support the reference voltage discharge time, reference voltage stabilization wait time (A), or reference voltage stabilization wait time (B). These times are handled as 0 clock cycles so simulation proceeds without them.

3.1.20 Clock output/buzzer output controller

When f_{MAIN} is selected as an output clock, the [Timing chart] window does not show the clock waveform of the PCLBUZn signal.

When $f_{MAIN}/2$ or a slower signal is selected as an output clock, the [Timing chart] window shows the clock waveform.

3.1.21 Executing illegal instructions

If an illegal instruction (instruction code: 0xFF) is executed, the target device will be reset, but the simulator will go into an endless loop (the illegal instruction will be executed repeatedly).

3.1.22 Digital filters of the remote control signal receiver (REMC)

The simulator does not simulate the digital filters of the remote control signal receiver (REMC).

3.1.23 Times taken for data transfer by the data transfer controller (DTC)

The times taken for data transfer by the data transfer controller (DTC) differ between the target device and the simulator.

[Target device]

- A response time is required from detection of a DTC activation source until data transfer starts.
- A waiting time is required for access to extended special function registers (2nd SFRs).
- The DTC puts the data transfer on hold when the CPU executes any instruction that holds the DTC pending.
- Access to the data bus by the CPU is put on hold during DTC transfer.

[Simulator]

- Data transfer starts immediately after detection of a DTC activation source.
- No waiting time is required even for access to extended special function registers (2nd SFRs).
- The DTC does not put the data transfer on hold even when the CPU executes any instruction that should hold the DTC pending.
- Access to the data bus by the CPU is not put on hold even during DTC transfer.

3.1.24 Repeat mode of the data transfer controller (DTC)

If any of the conditions listed below is satisfied while the data transfer controller (DTC) is in repeat mode, the DTC ignores activation sources and will thus fail to transfer data.

- A DTC transfer count register j (DTCCTj) is set to 00H (number of transfers: 256 times).
- A DTC block size register j (DTBLSj) is set to 00H (block size: 256 or 512 bytes).
- A DTC control register j (DTCCRj) is used to set the transfer data size to 16 bits and the corresponding DTC block size register j (DTBLSj) is used to set the block size to 256 bytes or more.

3.1.25 D/A converter

When no voltage value is set for the VDD pin, the default reference voltage of the D/A converter is 5.0 V.

To change the reference voltage, specify the desired voltage value for the VDD pin via the [Signal Data Editor] window or some other means.

3.1.26 Reference voltage of the comparators (CMP)

When no voltage value is set for the VDD pin, the simulator generates the reference voltage on the assumption that 5 V is being input to the VDD pin.

To change the reference voltage, specify the desired voltage value for the VDD pin via the [Signal Data Editor] window or some other means.

3.1.27 Digital filters in the comparators (CMP)

The simulator does not simulate the digital filters in the comparators (CMP).

3.1.28 Response time of the comparators

Since the simulator does not simulate the response time of the comparators, the response time is always 0 second. This does not change even if the speed of the comparators is changed in the comparator output control register (COMPOCR).

3.1.29 SFRs (WKUPMD and PSMCR) for the standby function

The following SFRs which control standby functions are not simulated.

Although read/write access for each register can proceed normally, the operation does not change even if the value is changed.

- Bit 0 (FWKUP) of the standby mode release setting register (WKUPMD)
- Bit 0 (RAMSDS) and bit 1 (RAMSDMD) of the memory power reduction control register (PSMCR)

3.1.30 Safety functions

The simulator does not support the following safety functions.

- Flash memory CRC operation function (high-speed CRC, general-purpose CRC)
- Flash memory guard function
- RAM parity error detection
- RAM guard function
- SFR guard function
- Illicit memory access detection
- Guard function of invalid memory access detection control register (IAWCTL)

3.1.31 Power supply for battery backup (VBAT)

The simulator does not simulate the power supply for battery backup (VBAT).

3.1.32 Output signals from the logic and event link controller (ELCL)

When any among f_{CLK} , f_{IHP} , f_{IMP} , or f_{SXP} is selected as an input signal for the logic and event link controller (ELCL) and this leads to the frequency of the clock in the logic cell block being higher than that of the main clock, the output signals of the ELCL may not be correctly displayed in the simulator GUI or in the [Virtual Board] panel.

3.1.33 Values calculated for current drawn when the ELCL is selected as the operating clock of UARTAn

With the simulator, when the ELCL is selected as the operating clock of UARTAn, the current value for UARTAn is 0 uA.

3.1.34 Values calculated for current drawn when an event input from the ELCL is selected as the counter clock of the 32-bit interval timer

With the simulator, when an event input from the ELCL is selected as the counter clock of the 32-bit interval timer, the current value for the 32-bit interval timer is 0 uA.

3.1.35 SSm registers in the serial array unit

During serial communications, when the operation start trigger of channel n (SSmn) in the serial channel start register m (SSm) is set to 1, operation of the simulator differs from that of the actual target device in the way stated below.

[Target device]

The target device stops communications and enters the suspended state.

[Simulator]

The simulator does not stop communications. Accordingly, the TSFmn and BFFmn bits in the serial status register mn (SSRmn) are not cleared to 0.

3.2 Usage of simulation functions

3.2.1 Simulation speed

The simulation speed of RL78/G23 simulator depends on the number of operating peripheral functions. If many peripheral functions are operating, the simulation speed becomes from several to ten times slower than the actual device. ^{Note}

With the use of only a few, or even no peripheral functions, the simulation speed may become faster than the actual device.

Note: The measurement environment for simulation speed is as follows.

CPU: 3.20 GHz (Quad-Core); memory: 8 Gbytes; OS: Windows10 64-bit edition

3.2.2 Pin waveforms in the [Timing chart] window

The maximum length of a pin waveform is 4096 signal-level changing points. After reaching this maximum length, the data will be overwritten from the oldest value. If this length is not sufficient, use the following methods.

- Reduce the number of registered pins
- Stop the user program at the place where you want to confirm the waveform by using a breakpoint

3.2.3 Controlling windows

The following keyboard operations are not available in the simulator windows ([Signal Data Editor], [I/O panel], and [Serial]).

- Navigation via tab or arrow keys (←, ↑, →, ↓)
- Deletion via the Del or Backspace keys
- Cut & paste and other operations via the Ctrl + C, V, X, A, or Z keys.

Perform the above operations as follows.

- Navigation: Navigate by using the mouse.
- Deletion: Right-click and perform the action from the context menu.
- Cut & paste, etc.: Right-click and perform the action from the context menu.

3.2.4 Closing the [Simulator GUI] window

The [Simulator GUI] window can only be closed by disconnecting from the debugging tool, or by closing CS+ in proper manner. The button cannot be used.

Additionally, although it appears that the button can be pressed if Aero is enabled in Windows, pressing this button will not close the [Simulator GUI] window.

3.2.5 Disconnecting the debug tool

CS+ may be closed if the debugging tool is disconnected while any of the following dialog boxes is open from the [Simulator GUI] window. Be sure that the following dialog boxes have been closed before disconnecting the simulator.

- Save As
- Open
- New
- Color
- Font
- Customize
- Loop
- Select Pin
- Search Data
- Format (UART)
- Format (CSI)
- Format (IIC)
- Message (e.g. Error)
- Parts Button Properties
- Analog Button Properties
- Parts Key Properties
- Parts Level Gauge Properties
- Parts Led Properties
- Parts Segment LED Properties
- Parts Matrix Led Properties
- Parts Buzzer Properties
- Pull up / Pull down
- Entry Bitmap
- Object Properties

3.2.6 [Serial] window

When using the [Serial] window as the data receiver for the simplified I²C of the serial array unit or IICA, only ACK can be generated after receiving the data. NACK cannot be generated.

3.2.7 Simulation of current drawn

The following notes apply to the function of measuring current.

- The current is calculated roughly as that drawn by the MCU alone based on the typical values (TYP.) for the actual devices. Note that the current values other than for the MCU are not included.
- The number of change points of measurable current is 200,000. The program stops when the number exceeds 200,000.

Revision History

Rev.	Date	Description	
		Page	Summary
1.00	June.01.22	-	First Edition

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(Rev.5.0-1 October 2020)

Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu,
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